# R15IQ3S-EHC3

## 15" Qualcomm Snapdragon™ 660 E Series HMI Panel PC



#### **KEY FEATURES**

- 15" 1024 x 768 Resolution with Projected Capacitive Multi-Touch (P-CAP)
- Qualcomm Snapdragon<sup>™</sup> 660 octa-core, 2.2 GHz CPU
- Fanless cooling system and ultra-low power consumption
- Front IP65 Water and Dust Proof



#### **SPECIFICATIONS**

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Display			
Resolution	1024x768	Size	15 inches
Contrast Ratio	2000:1	<b>Panel Brightness</b>	300
View Angles	88,88,88,88	Active Area	304.1x228.1 mm
Touch / Glass	Projected Capacitive Multi Touch Screen		
System Specificat	ion		
WLAN	Support (Optional)	ВТ	Support (Optional)
Processor	Qualcomm® Snapdragon™ 660 (Octa-Core 2.2 GHz)	Memory	3GB LPDDR4
Storage	32GB eMMC	Operating System	Android 9.0
Mechanical			
Dimension	367 x 291 x 65.8 mm	Mounting	Panel Mount VESA Mount
Enclosure	Metal Housing	<b>Cooling System</b>	Fanless design
Cut out	342x261 mm		
Environment			
Operating Humidity	10% to 90% (Non-Condensing)	Operating Temperature	0~50°C
Storage Temperature	-20~60°C	Shock	MIL-STD-810G Method 516.6
Vibration	MIL-STD-810G Method 514.6	IP rating	Front IP65
Certification			
Certification	CE, FCC		
IO Ports			
USB Port	2 x USB 2.0 (Type A), 1 x USB 3.0 (Type-C)	Serial Port	1 x RS232/422/485 (Default RS232)
SD Card Slot	1 x Micro SD card slot	Video	1 x Micro HDMI (Optional)
LAN	1 x LAN		
Accessory			
Accessory	100~240V AC to DC Adapter Power Cord		

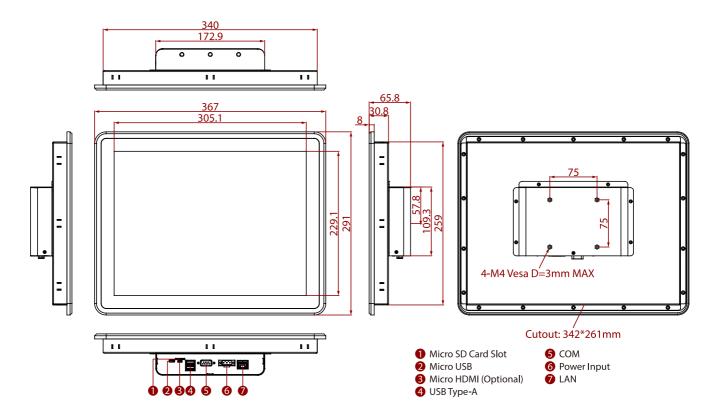
VESA screws

#### Power

Power Rating 12V DC with Terminal Block Adapter 12V 50W

#### **DIMENSIONS**

UNIT:MM



### **NOTE**

- 1. This is a simplified drawing and some components are not marked in detail.
- 2. The product shown in this datasheet is a standard model. For diagrams that contain customized or optional I/O, please contact the Winmate Sales Team for more information.
- 3. All specifications are subject to change without prior notice.